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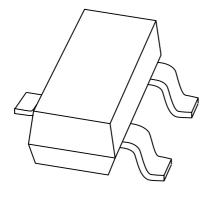
If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via **salesaddresses@nexperia.com**). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia

## **DISCRETE SEMICONDUCTORS**

# DATA SHEET



## **BF820**; **BF822** NPN high-voltage transistors

Product data sheet Supersedes data of 1999 Apr 15 2004 Jan 16



NXP Semiconductors Product data sheet

## **NPN** high-voltage transistors

BF820; BF822

#### **FEATURES**

• Low current (max. 50 mA)

• High voltage (max. 300 V).

#### **APPLICATIONS**

• Telephony and professional communication equipment.

#### **DESCRIPTION**

NPN high-voltage transistor in a SOT23 plastic package. PNP complements: BF821; BF823.

#### **MARKING**

TYPE NUMBER	MARKING CODE <sup>(1)</sup>
BF820	1V*
BF822	1X*

#### Note

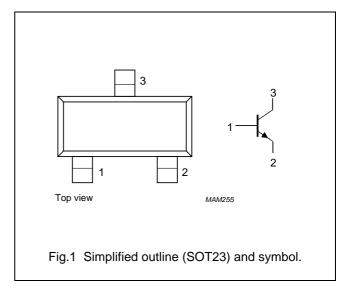
1. \* = p : Made in Hong Kong.

\* = t : Made in Malaysia.

\* = W : Made in China.

#### **PINNING**

PIN	DESCRIPTION	
1	base	
2	emitter	
3	collector	



#### **ORDERING INFORMATION**

TYPENUMBER	PACKAGE			
TIPENOMBER	NAME DESCRIPTION		VERSION	
BF820	_	plastic surface mounted package; 3 leads	SOT23	
BF822	_	plastic surface mounted package; 3 leads	SOT23	

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## NPN high-voltage transistors

BF820; BF822

#### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CBO</sub>	collector-base voltage	open emitter			
	BF820		_	300	V
	BF822		_	250	V
V <sub>CEO</sub>	collector-emitter voltage	open base			
	BF820		_	300	V
	BF822		_	250	V
V <sub>EBO</sub>	emitter-base voltage	open collector	_	5	V
I <sub>C</sub>	collector current (DC)		_	50	mA
I <sub>CM</sub>	peak collector current		_	100	mA
I <sub>BM</sub>	peak base current		_	50	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C; note 1	_	250	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T <sub>amb</sub>	operating ambient temperature		-65	+150	°C

#### Note

#### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	note 1	500	K/W

#### Note

1. Transistor mounted on an FR4 printed-circuit board.

#### **CHARACTERISTICS**

 $T_j = 25$  °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I <sub>CBO</sub>	collector-base cut-off current	I <sub>E</sub> = 0; V <sub>CB</sub> = 200 V	_	10	nA
		I <sub>E</sub> = 0; V <sub>CB</sub> = 200 V; T <sub>j</sub> =150 °C	_	10	μΑ
I <sub>EBO</sub>	emitter-base cut-off current	I <sub>C</sub> = 0; V <sub>EB</sub> = 5 V	_	50	nA
h <sub>FE</sub>	DC current gain	$I_C = 25 \text{ mA}; V_{CE} = 20 \text{ V}$	50	_	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_C = 30 \text{ mA}; I_B = 5 \text{ mA}$	_	600	mV
C <sub>re</sub>	feedback capacitance	$I_C = I_c = 0$ ; $V_{CB} = 30 \text{ V}$ ; $f = 1 \text{ MHz}$	_	1.6	pF
f <sub>T</sub>	transition frequency	$I_C = 10 \text{ mA}; V_{CE} = 10 \text{ V}; f = 100 \text{ MHz}$	60	_	MHz

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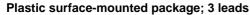
<sup>1.</sup> Transistor mounted on an FR4 printed-circuit board.

## NPN high-voltage transistors

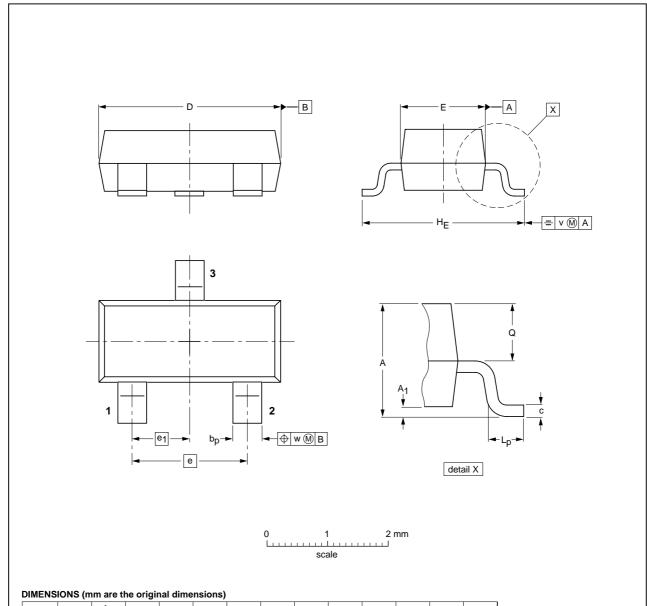
BF820; BF822

#### **PACKAGE OUTLINE**

UNIT



SOT23



OUTLINE	REFERENCES		EUROPEAN	ICCUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT23		TO-236AB				<del>-04-11-04-</del> 06-03-16

e<sub>1</sub>

 $\mathbf{H}_{\mathsf{E}}$ 

 $\mathsf{L}_\mathsf{p}$ 

0.45

0.55

0.1

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bp

0.38

max

0.9

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## NPN high-voltage transistors

BF820; BF822

#### **DATA SHEET STATUS**

DOCUMENT STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)</sup>	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

#### **Notes**

- 1. Please consult the most recently issued document before initiating or completing a design.
- 2. The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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## **NXP Semiconductors**

#### **Customer notification**

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

#### **Contact information**

For additional information please visit: http://www.nxp.com
For sales offices addresses send e-mail to: salesaddresses@nxp.com

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